

100mA, 45V Low V_F Schottky Barrier Diode

FEATURES

- Designed for mounting on small surface
- Low Capacitance
- Low forward voltage drop
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Adapters
- For switching power supply
- Low stored charge
- Inverter

MECHANICAL DATA

• Case: SOD-323F

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 1A whisker test

· Polarity: Indicated by cathode band

• Weight: 4.60mg (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
l _F	100	mA	
V_{RRM}	45	V	
I _{FSM}	1	Α	
V _F at I _F = 10mA	0.45	V	
T _{J MAX}	125	°C	
Package	SOD-323F		
Configuration	Single die		







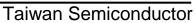


SOD-323F



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	RB500V-40	UNIT
Marking code on the device			S9	
Peak reverse voltage		V_{RM}	45	V
Reverse voltage		V_R	40	V
Forward current		I _F	100	mA
Non-repetitive peak forward surge current	t = 8.3ms	I _{FSM}	1	Α
Junction temperature range		TJ	-40 to +125	°C
Storage temperature range		T _{STG}	-40 to +125	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient thermal resistance	R _{OJA}	500	°C/W





ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Reverse Breakdown Voltage	$I_R = 100 \mu A, T_J = 25 ^{\circ} C$	V_{BR}	45	-	V
Forward voltage ⁽¹⁾	I _F = 10mA, T _J = 25°C	V _F	-	0.475	V
Reverse current @ rated V _R ⁽²⁾	$V_R = 10V, T_J = 25^{\circ}C$	I _R	-	1	μA
Junction capacitance	$1MHz, V_R = 10V$	CJ	-	6	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
RB500V-40 RR	SOD-323F	3,000 / 7" Tape & Reel	
RB500V-40 RRG	SOD-323F	3,000 / 7" Tape & Reel	
RB500V-40 R9	SOD-323F	10,000 / 13" Tape & Reel	
RB500V-40 R9G	SOD-323F	10,000 / 13" Tape & Reel	

Notes:

1. "G" means green compound (halogen-free according to IEC 61249-2-21)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

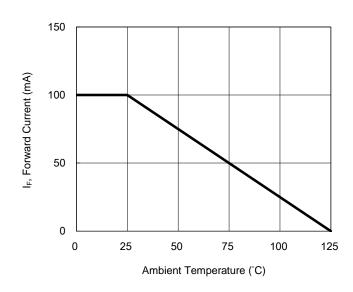


Fig.2 Typical Forward Characteristics

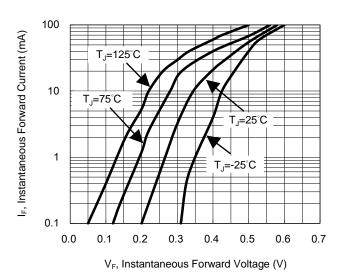


Fig.3 Typical Reverse Characteristics

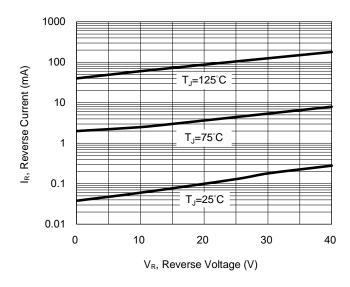
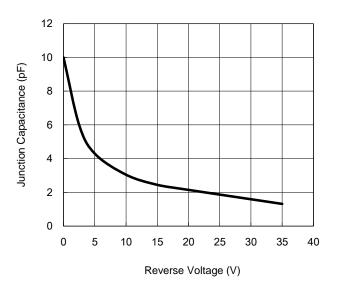


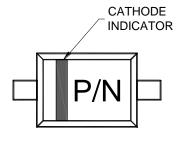
Fig.4 Typical Junction Capacitance





PACKAGE OUTLINE DIMENSIONS

SOD-323F ⊕ | 0.10 M | C | A | B | 2.50^{+0.30}_{-0.20} 0.40±0.10 0.325±0.075 ⊕ 0.10 M C A B 1.25±0.10 4 Α В 1.70±0.10 0.50±0.10 $\sqrt{4}$ 10° MAX 10° MAX **SEATING** $0.75^{+0.35}_{-0.15}$ **PLANE** C 0.15^{+0.11} -0.10 2.00 -0.50 0.70



MARKING DIAGRAM

P/N = MARKING CODE

SUGGESTED PAD LAYOUT

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: EIAJ ED-7500A-1, SC-90.
- MOLDED PLASTIC BODY LATERAL
 DIMENSIONS DO NOT INCLUDE MOLD
 FLASH, PROTRUSIONS OR GATE BURRS.
- 5. DWG NO. REF: HQ2SD07-SOD323F-018 REV A.



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